

Opto Plus LED Corp.
0.51" SMD Type LED Display
OPS-Q5110LE-GW
OPS-Q5111LE-GW

● **EDIT HISTORY**

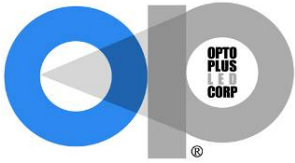
Version A: Oct. 04, 2013

Preliminary spec.

Version B: Oct. 14, 2015

1. Modify mechanical dimensions.
2. Add bin & hue data.

Manufacture	Examination	Approving



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● **FEATURES**

- 0.51 inch (13.0 mm) Digit Height.
- SMD type.
- Low current operation.
- Gray face, White segment.
- RoHS compliant, Pb Free.

● **DESCRIPTION**

The OPS-Q5110LE-GW & OPS-Q5111LE-GW are 0.51 inch (13.0mm) height Quadruple digit 7-segment display.

This device utilizes Super Bright Red LED chip which are made from AlGaInP On a transparent GaAs, substrate.

The display has Gray face, White segment.

● **DEVICE**

PART NO	DESCRIPTION
OPS-Q5110LE-GW	Common Anode
OPS-Q5111LE-GW	Common Cathode

RoHS Compliance



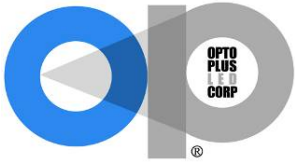
Pb free.



Version: B Date: 10/14/2015

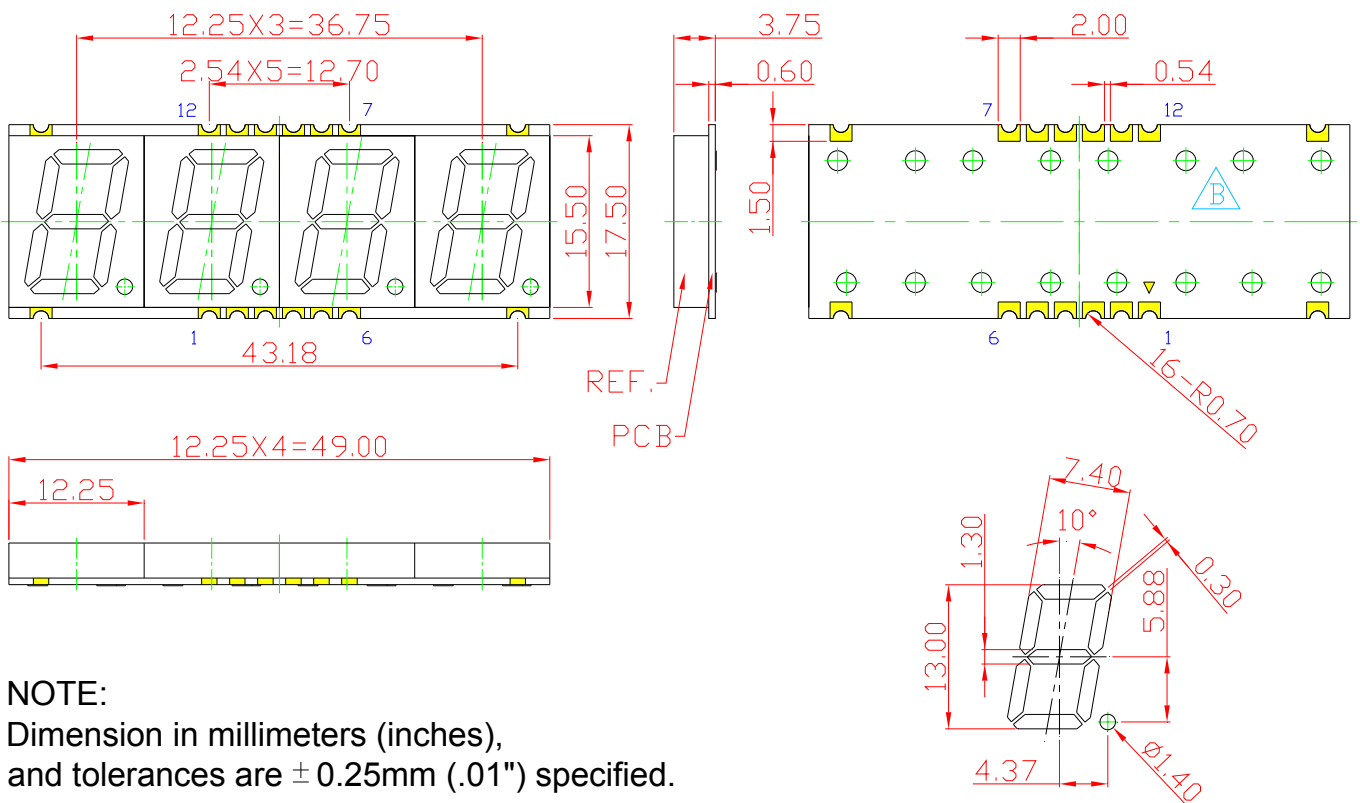
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Website: www.opled.com.tw E-mail: sales@opled.com.tw Tel: 886-2-2222-5698 Fax: 886-2-2222-2566

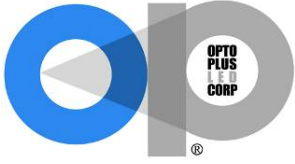


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● **MECHANICAL DIMENSIONS**



NOTE:
 Dimension in millimeters (inches),
 and tolerances are $\pm 0.25\text{mm}$ (.01") specified.



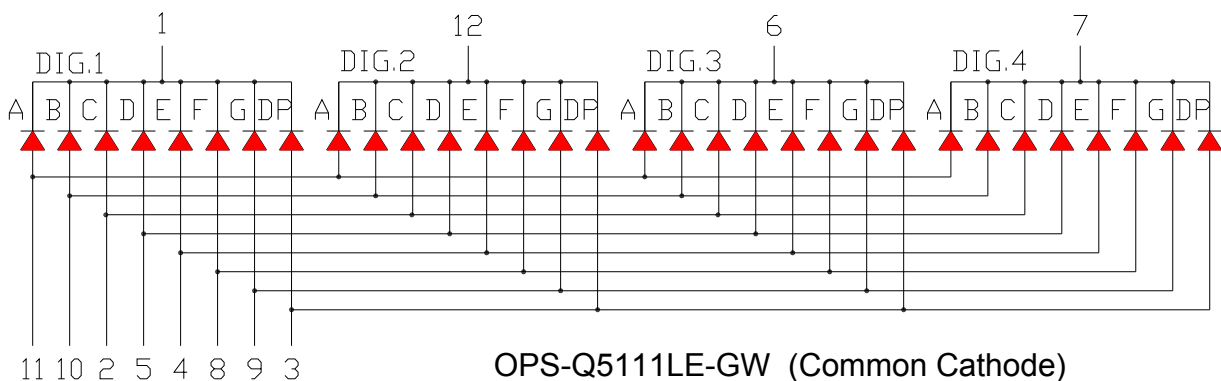
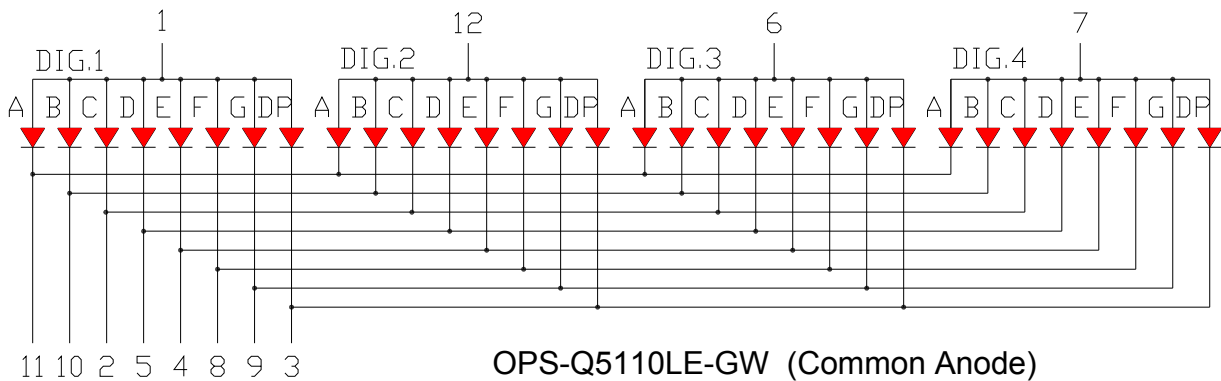
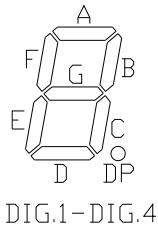
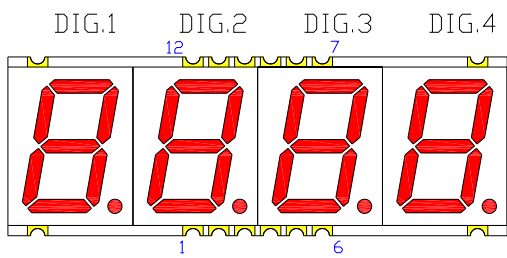
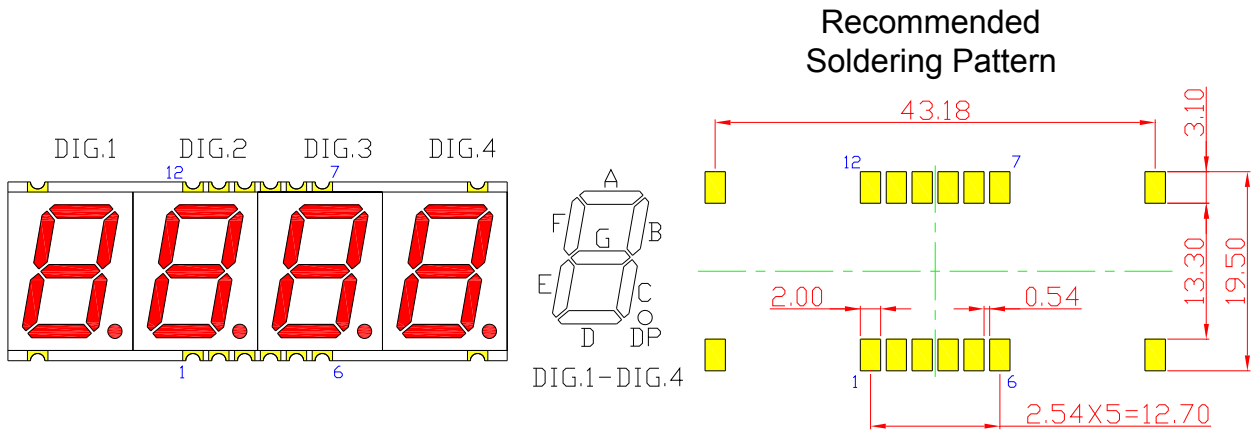
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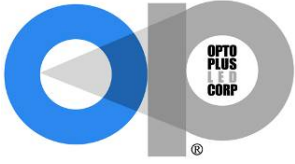
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● TYPICAL INTERNAL EQUIVALENT CIRCUIT





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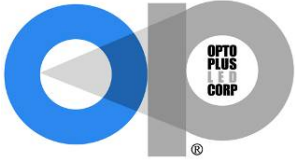
● **LE: SUPER BRIGHT RED (AlGaInP/GaAs)**

ABSOLUTE MAXIMUM RATING AT Ta=25°C

Parameter	Symbol	Maximum Rating	Unit
Power dissipation	P_{AD}	70	mW
Derating liner from 25°C	-	0.28	mA / °C
Continuous forward current	I_{AF}	25	mA
Peak current (duty cycle 1/10, 1kHz)	I_{PF}	90	mA
Reverse voltage	V_R	5	V
Operating temperature	T_{OPR}	-40 to +105	°C
Storage temperature	T_{STG}	-40 to +105	°C

ELECTRICAL - OPTICAL CHARACTERISTICS AT Ta=25°C

Characteristic	Symbol	Condition	Min.	Type.	Max.	Unit
Forward Voltage, (Per Dice)	V_F	$I_F = 20mA$	-	2.0	2.6	V
Reverse Current, (Per Dice)	I_R	$V_R = 5V$	-	-	10	μA
Peak Wavelength	λ_P	$I_F = 20mA$	-	632	-	nm
Dominant Wavelength	λ_D	$I_F = 20mA$	619	-	629	nm
Luminous Intensity	I_V	$I_F = 20mA$	20	-	65	mcd
Spectral radiation bandwidth	$\Delta\lambda$	$I_F = 20mA$	-	20	-	nm



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● **LE: BIN GRADE (Unit : mcd) 20mA**

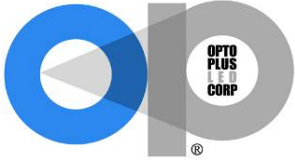
	L	M	N
Super Bright Red	20.1 - 35.0	35.1 - 50.0	50.1 - 65.0

● **LE: HUE GRADE (λ_D : nm)**

1	2	3
619.0 – 622.0	622.1 – 626.0	626.1 – 629.0

● **AVAILABLE BIN / HUE TABLE**

L1	M1	N1
L2	M2	N2
L3	M3	N3



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● LE: SUPER BRIGHT RED (AlGaInP/GaAs) CURVE

Typical Electro-optical Characteristic Curves
(25 °C Free Air Temperature Unless Otherwise Specified)

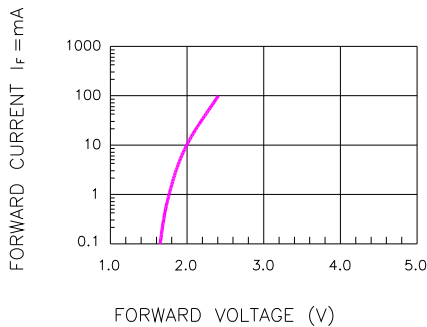


Fig.1 FORWARD CURRENT VS. FORWARD VOLTAGE

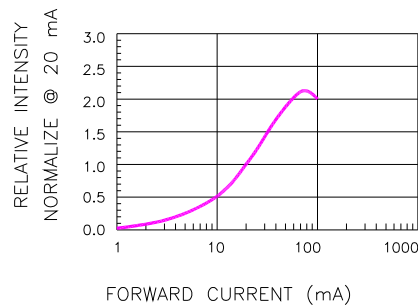


Fig.2 RELATIVE INTENSITY VS. FORWARD CURRENT

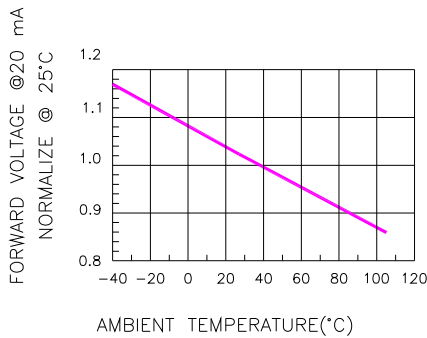


Fig.3 FORWARD VOLTAGE VS. TEMPERATURE

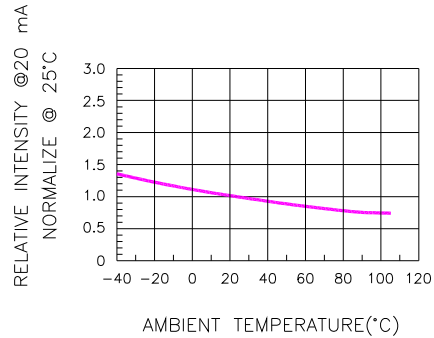


Fig.4 RELATIVE INTENSITY VS. TEMPERATURE

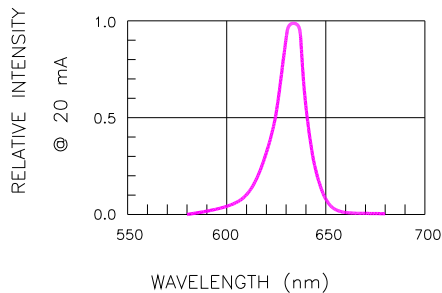


Fig.5 RELATIVE INTENSITY VS. WAVELENGTH

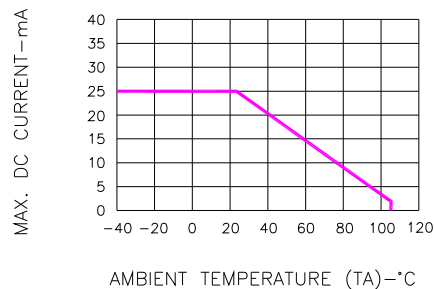
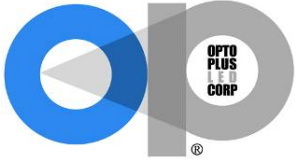


Fig.6 MAX. ALLOWABLE DC CURRENT VS. AMBIENT TEMPERATURE

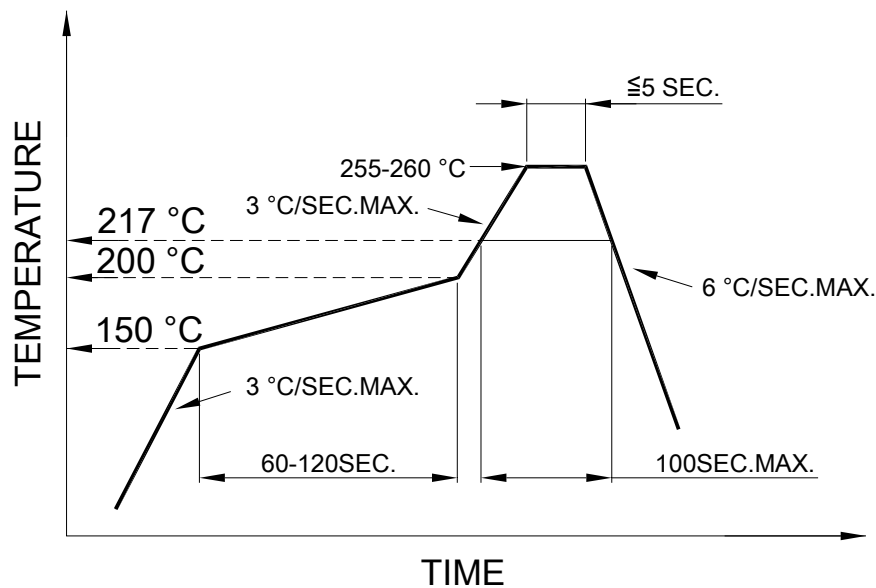


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● **SMT REFLOW SOLDERING INSTRUCTIONS**

SMT Soldering Profile

Pb free reflow soldering Profile



- We recommend the reflow temperature 245°C (+/- 5°C).
The maximum soldering temperature should be limited to 260°C.
- Number of reflow process shall be 2 times or less.

● **SOLDERING IRON**

Basic spec is ≤ 4 sec when 260°C. If temperature is higher, time should be shorter (+10°C → 1 sec). Power dissipation of Iron should be smaller than 15W, and temperature should be controllable. Surface temperature of the device should be under 230°C.

● **REWORK**

- Customer must finish rework within 3 sec. under 350°C.
- The head of soldering iron cannot touch copper foil.